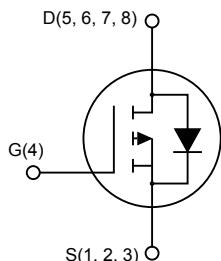
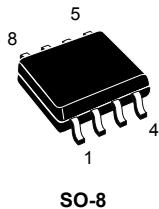


P-channel -40 V, 12.5 mΩ typ., -10 A STripFET F6 Power MOSFET in SO-8 package



AM01475v4

Features

Order code	V _{DS}	R _{DS(on)} max.	I _D
STS10P4LLF6	-40 V	15 mΩ	-10 A

- Very low on-resistance
- Very low gate charge
- High avalanche ruggedness
- Low gate drive power loss

Applications

- Switching applications

Description

This device is a P-channel Power MOSFET developed using the STripFET F6 technology, with a new trench gate structure. The resulting Power MOSFET exhibits very low R_{DS(on)} in all packages.



Product status link

[STS10P4LLF6](#)

Product summary

Order code	STS10P4LLF6
Marking	10P4L
Package	SO-8
Packing	Tape and reel

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{DS}	Drain-source voltage	-40	V
V_{GS}	Gate-source voltage	± 20	V
I_D	Drain current (continuous) at $T_{amb} = 25\text{ }^\circ\text{C}$	-10	A
	Drain current (continuous) at $T_{amb} = 100\text{ }^\circ\text{C}$	-5.6	A
I_{DM} ⁽¹⁾	Drain current (pulsed)	-40	A
P_{TOT}	Total power dissipation at $T_{amb} = 25\text{ }^\circ\text{C}$	2.7	W
T_{stg}	Storage temperature	-55 to 150	$^\circ\text{C}$
T_J	Operating junction temperature	150	$^\circ\text{C}$

1. Pulse width limited by safe operating area.

Table 2. Thermal data

Symbol	Parameter	Value	Unit
R_{thJA} ⁽¹⁾	Thermal resistance, junction-to-ambient	47	$^\circ\text{C}/\text{W}$

1. When mounted on 1 inch² FR-4 board, 2 oz. Cu., $t \leq 10$ sec.

2 Electrical characteristics

($T_C = 25^\circ\text{C}$ unless otherwise specified)

Table 3. Static

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(\text{BR})\text{DSS}}$	Drain-source breakdown voltage	$I_D = -250 \mu\text{A}$	-40			V
I_{DSS}	Zero gate voltage drain current	$V_{\text{DS}} = -40 \text{ V}$			-1	μA
		$V_{\text{DS}} = -40 \text{ V}, T_C = 125^\circ\text{C}$			-10	μA
I_{GSS}	Gate-body leakage current	$V_{\text{DS}} = 0 \text{ V}, V_{\text{GS}} = \pm 20 \text{ V}$			± 100	nA
$V_{\text{GS}(\text{th})}$	Gate threshold voltage	$V_{\text{DS}} = V_{\text{GS}}, I_D = -250 \mu\text{A}$	-1		-2.5	V
$R_{\text{DS}(\text{on})}$	Static drain-source on-resistance	$V_{\text{GS}} = -10 \text{ V}, I_D = -3 \text{ A}$		12.5	15	$\text{m}\Omega$
		$V_{\text{GS}} = -4.5 \text{ V}, I_D = -3 \text{ A}$		17	20	

Table 4. Dynamic

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{iss}	Input capacitance	$V_{\text{DS}} = -25 \text{ V}, f = 1 \text{ MHz}, V_{\text{GS}} = 0 \text{ V}$	-	3525	-	pF
C_{oss}	Output capacitance		-	344	-	pF
C_{rss}	Reverse transfer capacitance		-	238.5	-	pF
Q_g	Total gate charge	$V_{\text{DD}} = -20 \text{ V}, I_D = -10 \text{ A}, V_{\text{GS}} = -4.5 \text{ V}$ (see Figure 13. Test circuit for gate charge behavior)	-	34	-	nC
Q_{gs}	Gate-source charge		-	11.3	-	nC
Q_{gd}	Gate-drain charge		-	13.8	-	nC

Table 5. Switching times

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{\text{d}(\text{on})}$	Turn-on delay time	$V_{\text{DD}} = -20 \text{ V}, I_D = -5 \text{ A}, R_G = 4.7 \Omega, V_{\text{GS}} = -10 \text{ V}$ (see Figure 12. Test circuit for resistive load switching times)	-	49.4	-	ns
t_r	Rise time		-	60.6	-	ns
$t_{\text{d}(\text{off})}$	Turn-off-delay time		-	170	-	ns
t_f	Fall time		-	20	-	ns

Table 6. Source drain diode

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{\text{SD}}^{(1)}$	Forward on voltage	$V_{\text{GS}} = 0 \text{ V}, I_{\text{SD}} = -3 \text{ A}$	-		-1.1	V
t_{rr}	Reverse recovery time	$I_{\text{SD}} = -5 \text{ A}, \text{di/dt} = 100 \text{ A}/\mu\text{s}, V_{\text{DD}} = -32 \text{ V}, T_J = 150^\circ\text{C}$ (see Figure 14. Test circuit for inductive load switching and diode recovery times)	-	29		ns
Q_{rr}	Reverse recovery charge		-	27.6		nC
I_{RRM}	Reverse recovery current		-	-1.9		A

1. Pulse test: pulse duration = 300 μs , duty cycle 1.5%.

2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

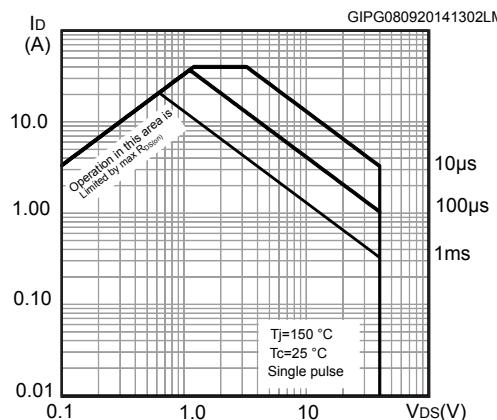


Figure 2. Thermal impedance

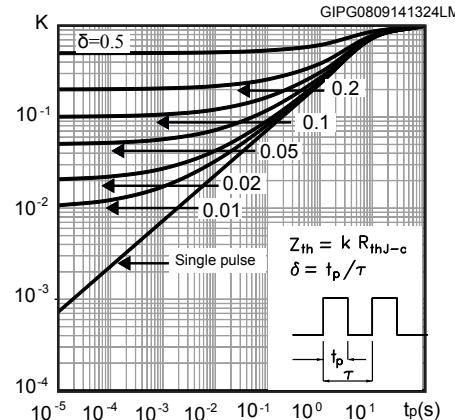


Figure 3. Output characteristics

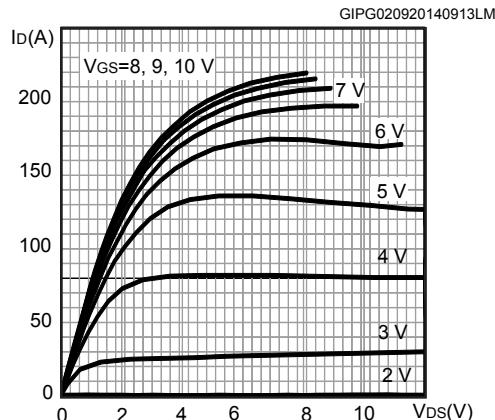


Figure 4. Transfer characteristics

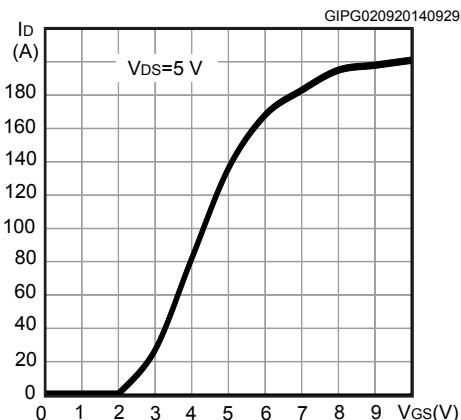


Figure 5. Gate charge vs gate-source voltage

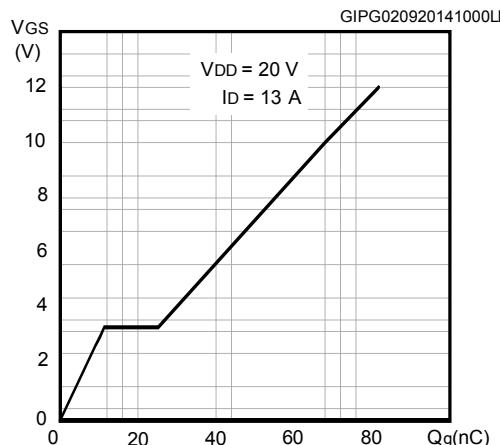
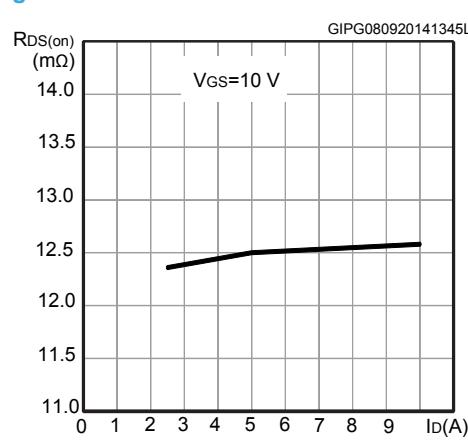
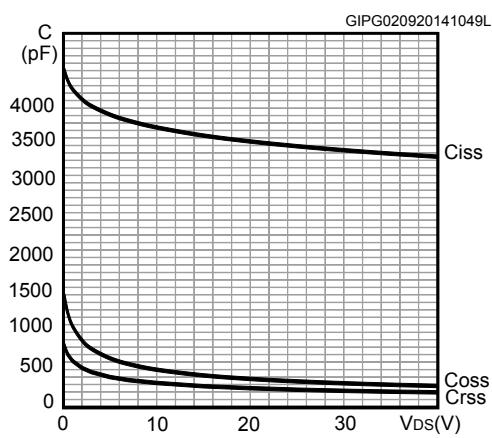
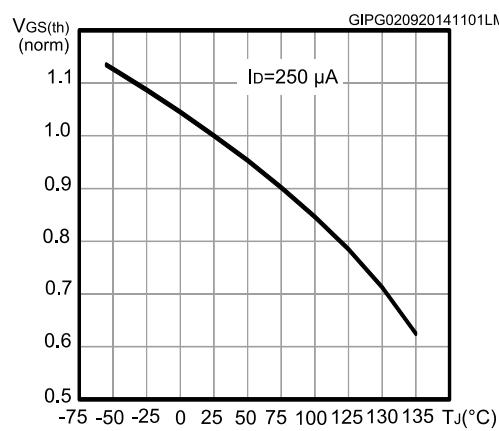
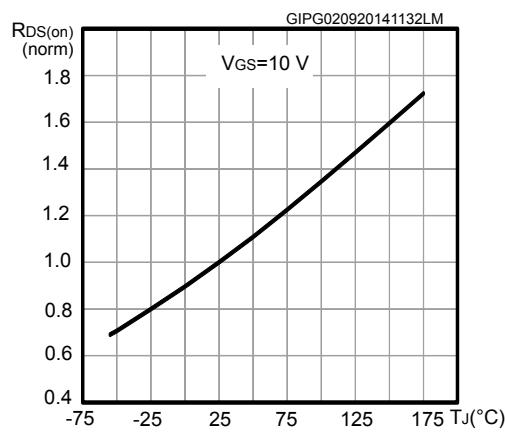
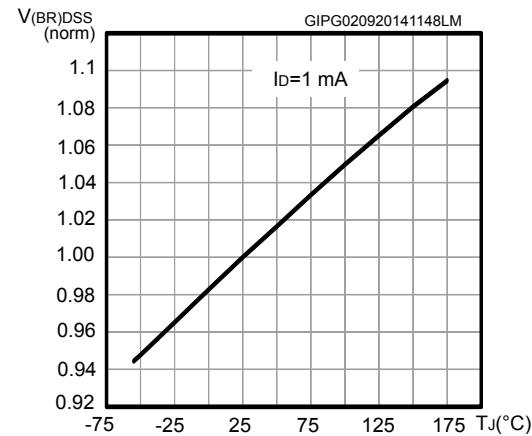
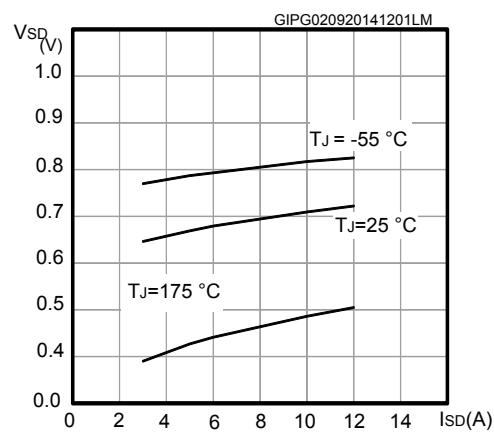


Figure 6. Static drain-source on-resistance



Note:

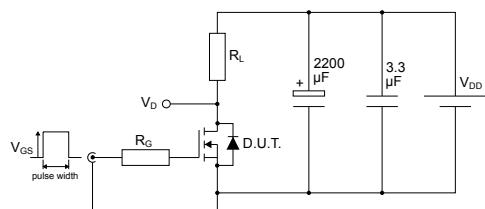
For the P-channel Power MOSFET, current and voltage polarities are reversed.

Figure 7. Capacitance variation

Figure 8. Normalized gate threshold voltage vs temperature

Figure 9. Normalized on-resistance vs temperature

Figure 10. Normalized $V_{BR(DSS)}$ vs temperature

Figure 11. Source-drain diode forward characteristics


Note: For the P-channel Power MOSFET, current and voltage polarities are reversed.

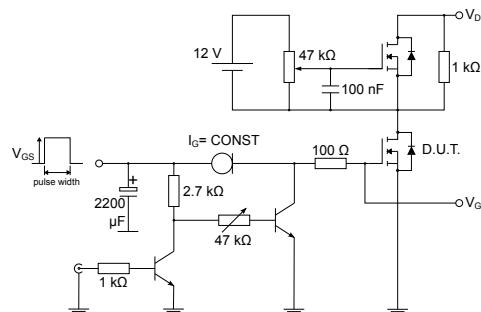
3 Test circuits

Figure 12. Test circuit for resistive load switching times



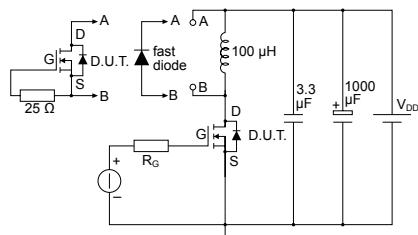
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Figure 13. Test circuit for gate charge behavior



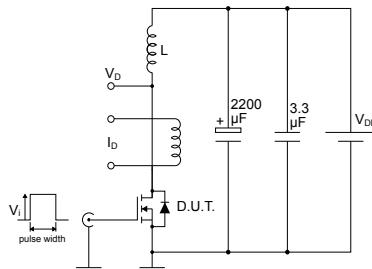
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Figure 14. Test circuit for inductive load switching and diode recovery times



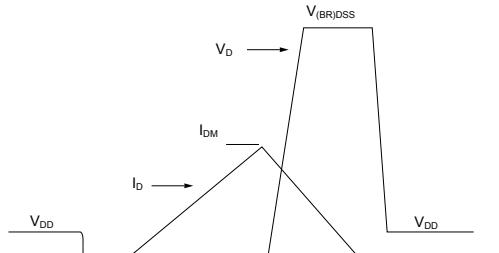
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Figure 15. Unclamped inductive load test circuit



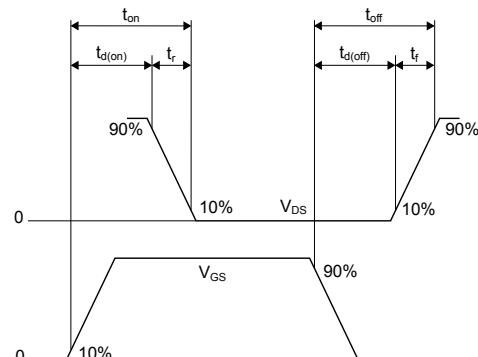
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Figure 16. Unclamped inductive waveform



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Figure 17. Switching time waveform



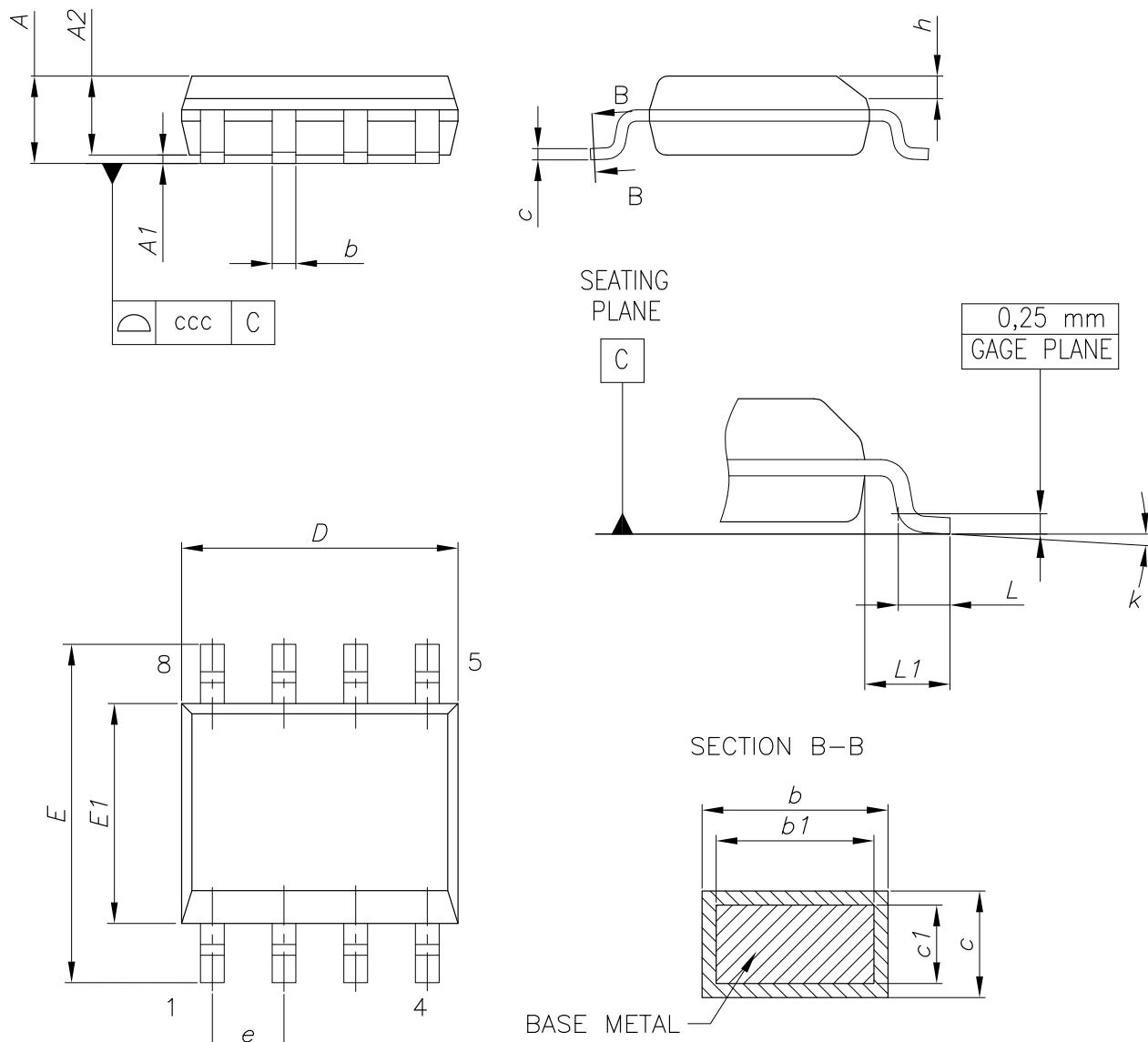
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4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

4.1 SO-8 package information

Figure 18. SO-8 package outline

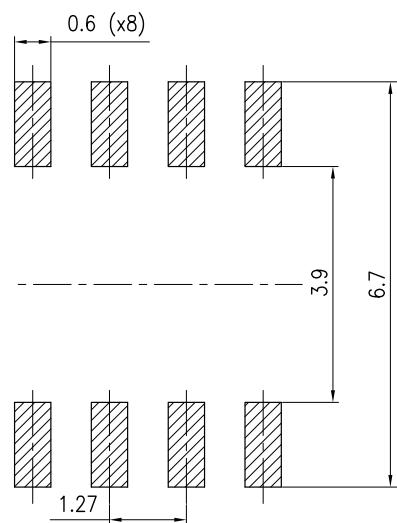


0016023_So-807_fig2_Rev10

Table 7. SO-8 mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A			1.75
A1	0.10		0.25
A2	1.25		
b	0.31		0.51
b1	0.28		0.48
c	0.10		0.25
c1	0.10		0.23
D	4.80	4.90	5.00
E	5.80	6.00	6.20
E1	3.80	3.90	4.00
e		1.27	
h	0.25		0.50
L	0.40		1.27
L1		1.04	
L2		0.25	
k	0°		8°
ccc			0.10

Figure 19. SO-8 recommended footprint (dimensions are in mm)



0016023_So-807_footprint_Rev10

4.2 SO-8 packing information

Figure 20. SO-8 tape and reel dimensions

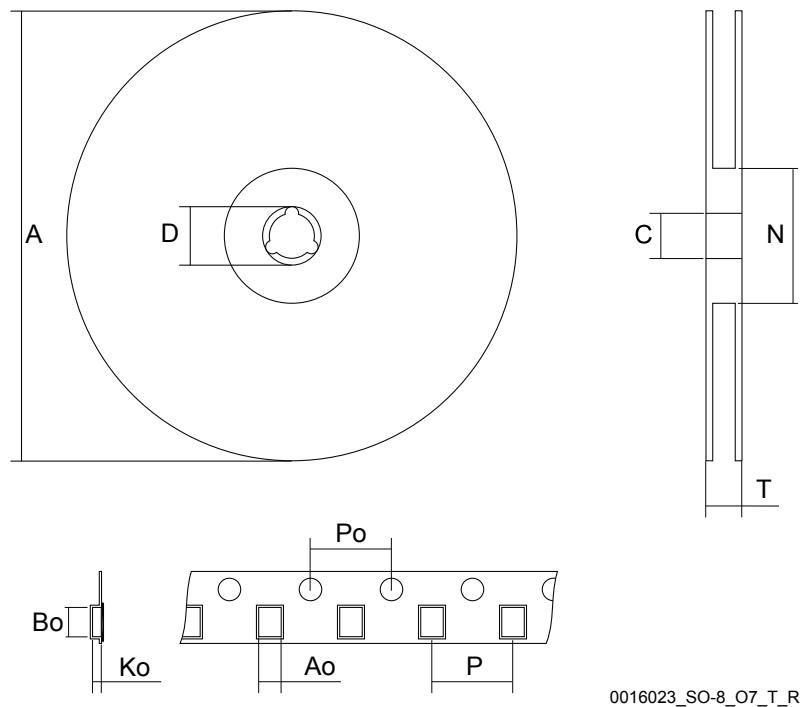


Figure 21. Tape orientation

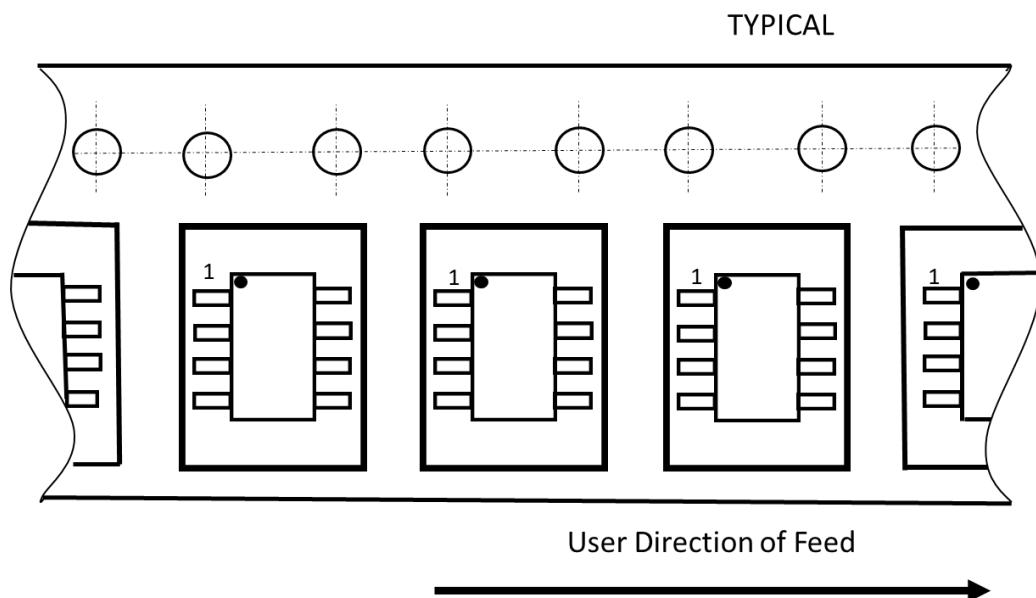


Table 8. SO-8 tape and reel mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A			330
C	12.8		13.2
D	20.2		
N	60		
T			22.4
Ao	6.5		6.7
Bo	5.4		5.6
Ko	2.0		2.2
Po	3.9		4.1
P	7.9		8.1

Revision history

Table 9. Document revision history

Date	Revision	Changes
20-Jan-2014	1	First revision.
09-Sep-2014	2	Changed the title. Updated Section "Features" and Section "Description". Updated Table 4: "On/off states", Table 5: "Dynamic", Table 6: "Switching times", Table 7: "Source-drain diode". Added Section 3: "Electrical characteristics (curves)".
16-Dec-2014	3	Document status promoted from preliminary data to production data. Minor text changes.
09-Dec-2020	4	Updated title and features in cover page. Updated Section 1 Electrical ratings and Section 2 Electrical characteristics. Minor text changes.
21-Jan-2021	5	Updated Internal schematic. Minor text changes.

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